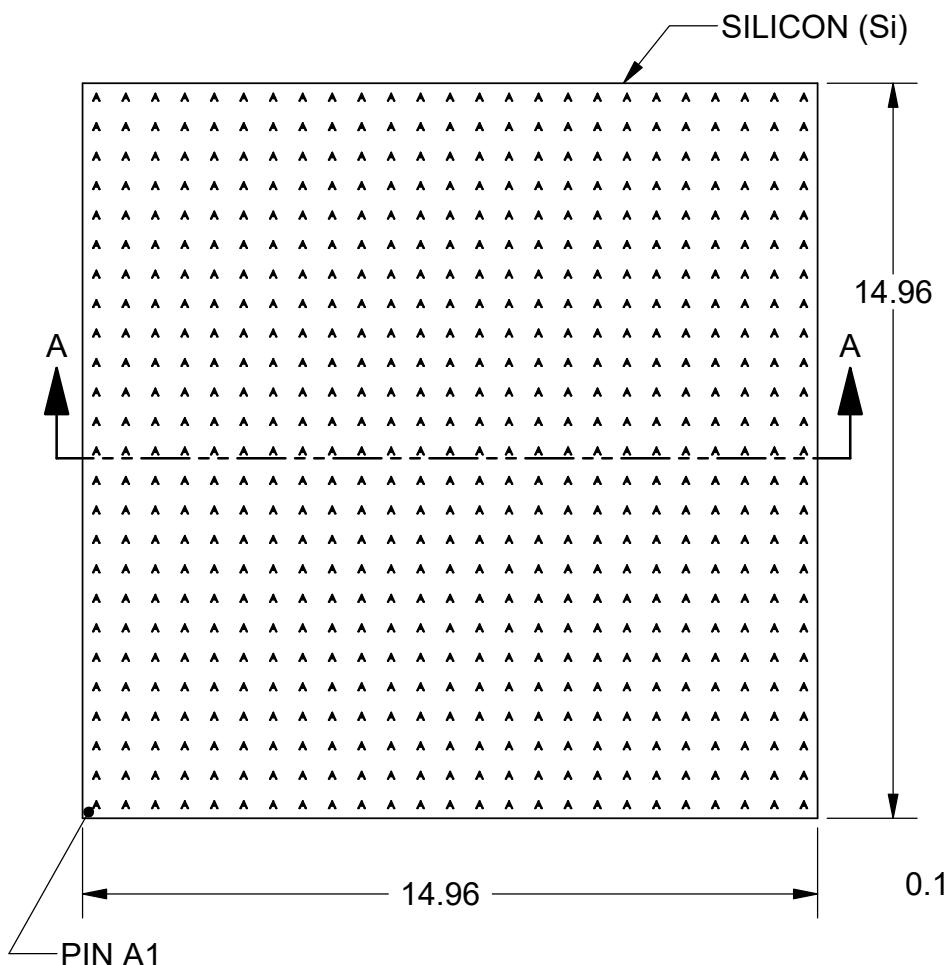
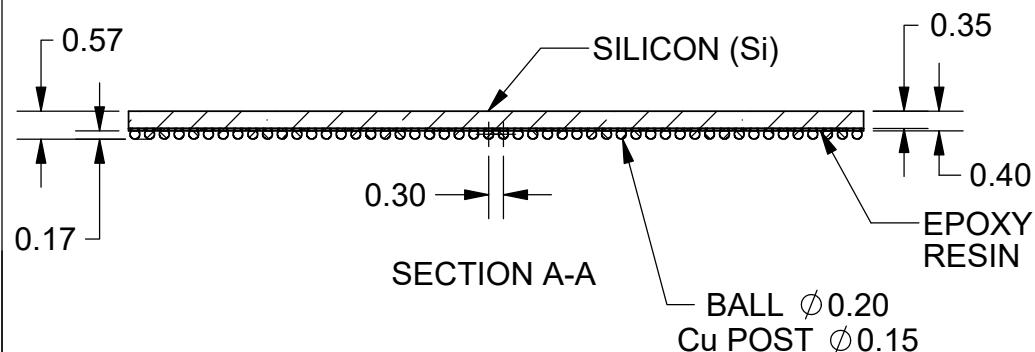
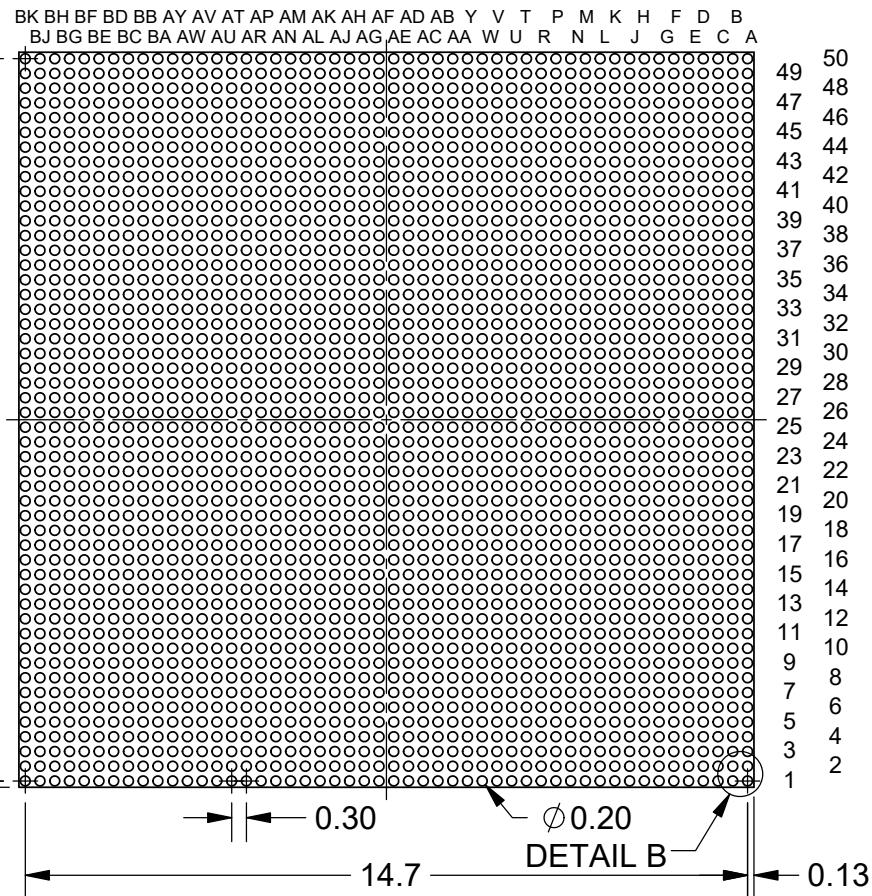


TOP VIEW



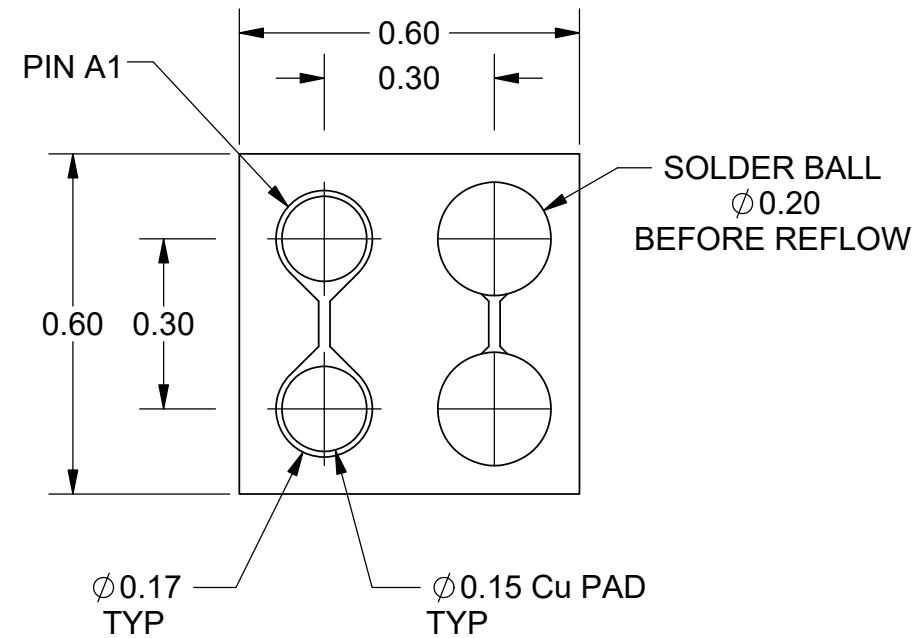
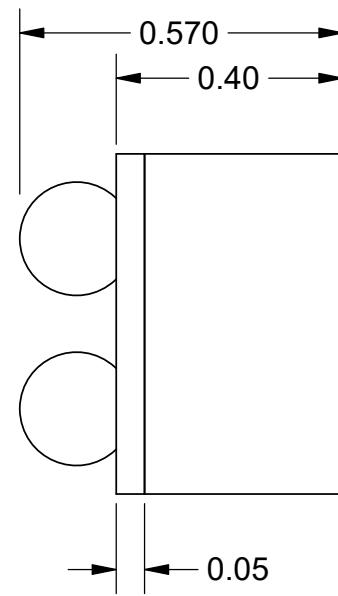
PAD VIEW



Notes: (Unless Otherwise Specified).
 1) ALL DIMENSIONS ARE IN MM.
 2) PAD ALLOY: Cu (50 μ m THICK).
 3) PAD Cu DIAMETER 0.15mm.
 4) SOLDER BALL ALLOY: SAC305.
 5) DAISY CHAIN PATTERN (SEE PAGE 3/4).

TOLERANCE UNLESS NOTED		APPROVALS	DATE	TopLine
X.X	+/- 0.1	DRAWN	J. Hines	
X.XX	+/- 0.05	ENG	M. Hart	10/19/2018
X.XXX	+/- 0.025			TITLE
				WLP2500T.3-DC507D
ALL DIMENSIONS IN <input type="checkbox"/> INCHES <input checked="" type="checkbox"/> MILLIMETERS		MFG		2500-L P=0.3mm
ANGLES +/- 0.5°		QA	SCALE	
		CUST	6.5:1	SIZE
		REVISED		A
			DO NOT SCALE DRAWING	535070
				REV B
SHEET 1 OF 6				

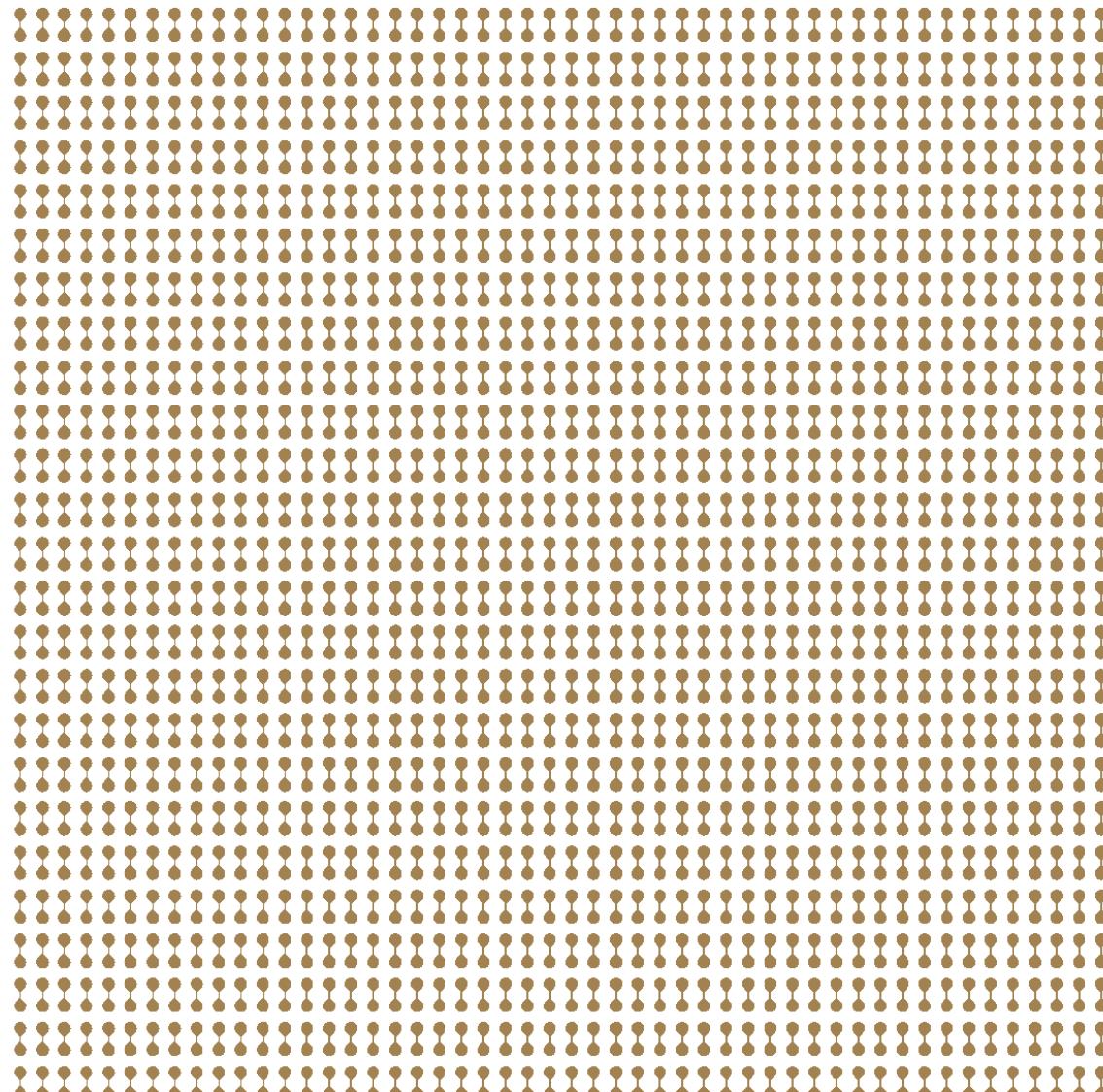
DETAIL B



TopLine			
TITLE WLP2500T.3-DC507D			
2500-L P=0.3mm			
SCALE 75:1	SIZE A	DRAWING NO. 535070	REV B
DO NOT SCALE DRAWING			SHEET 2 OF 6

DAISY CHAIN PATTERN
PAD VIEW

BK BH BF BD BB AY AV AT AP AM AK AH AF AD AB Y V T P M K H F D B
BJ BG BE BC BA AW AU AR AN AL AJ AG AE AC AA W U R N L J G E C A

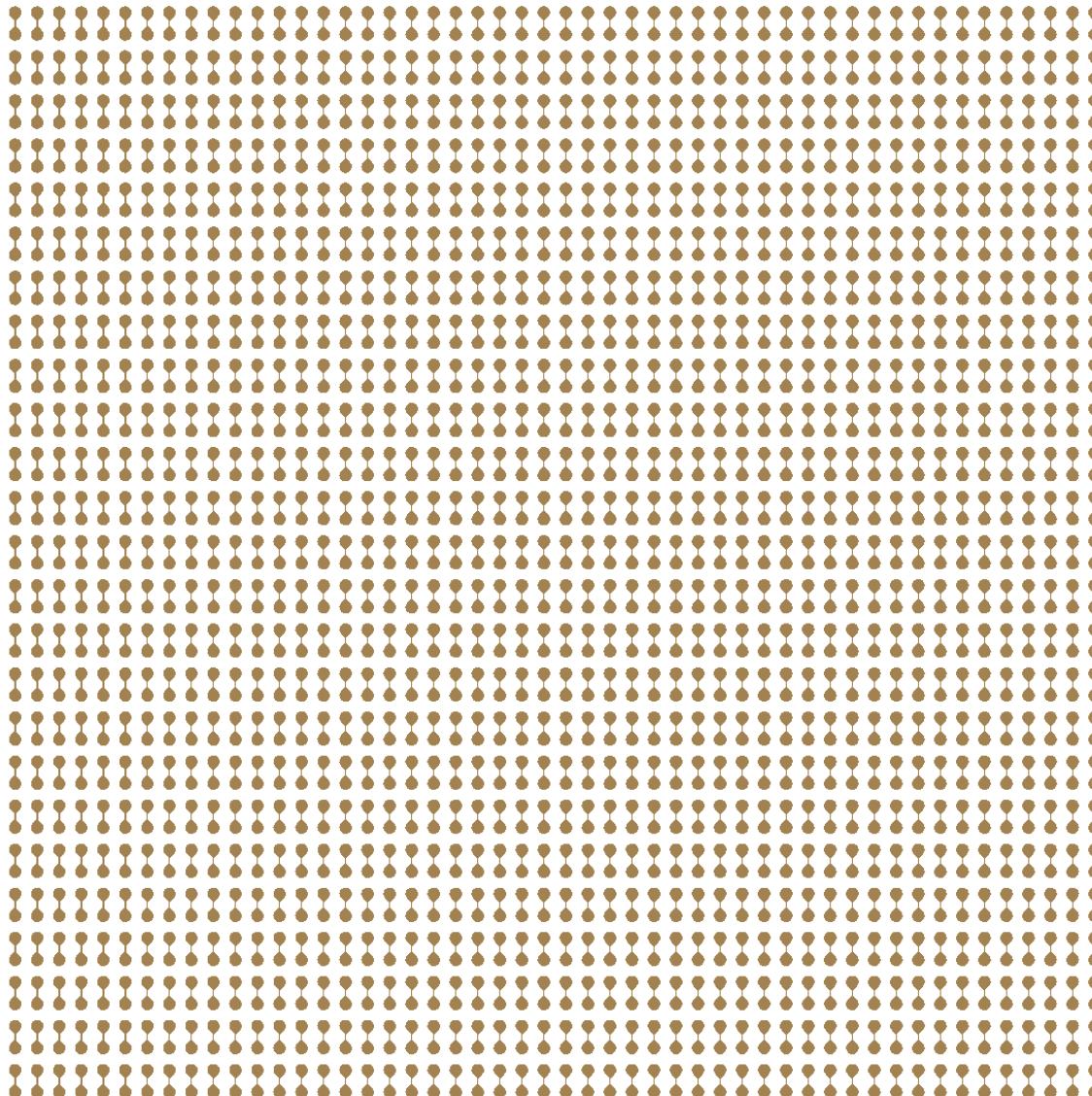


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TopLine			
TITLE WLP2500T.3-DC507D			
	2500-L P=0.3mm		
SCALE 10:1	SIZE A	DRAWING NO. 535070	REV B
DO NOT SCALE DRAWING			SHEET 3 OF 6

DAISY CHAIN PATTERN
TOP X-RAY VIEW OF PADS

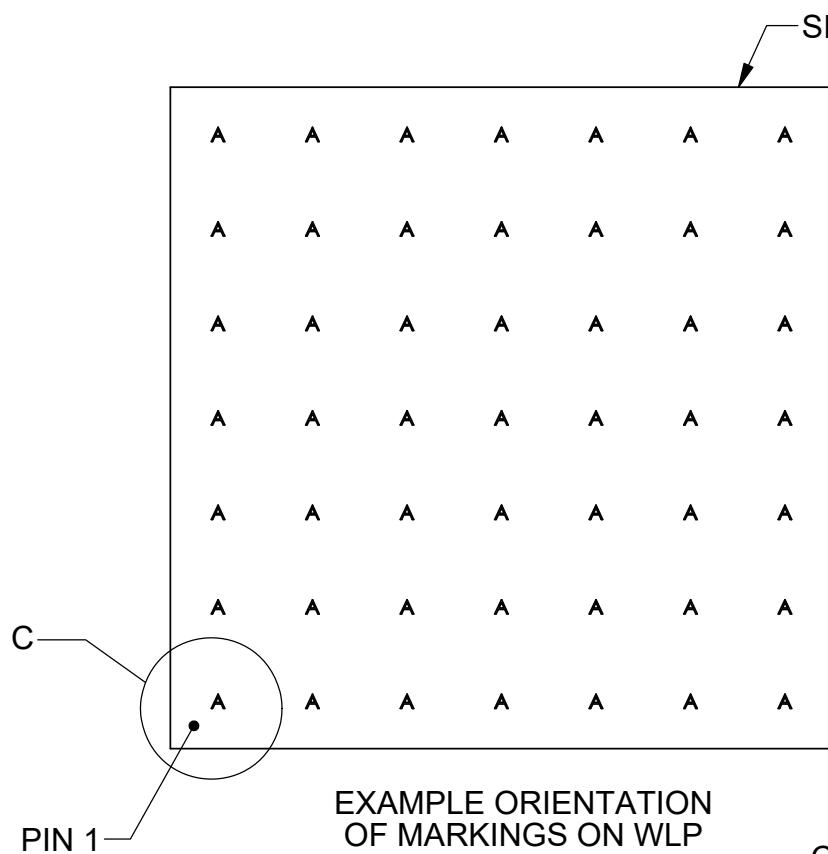
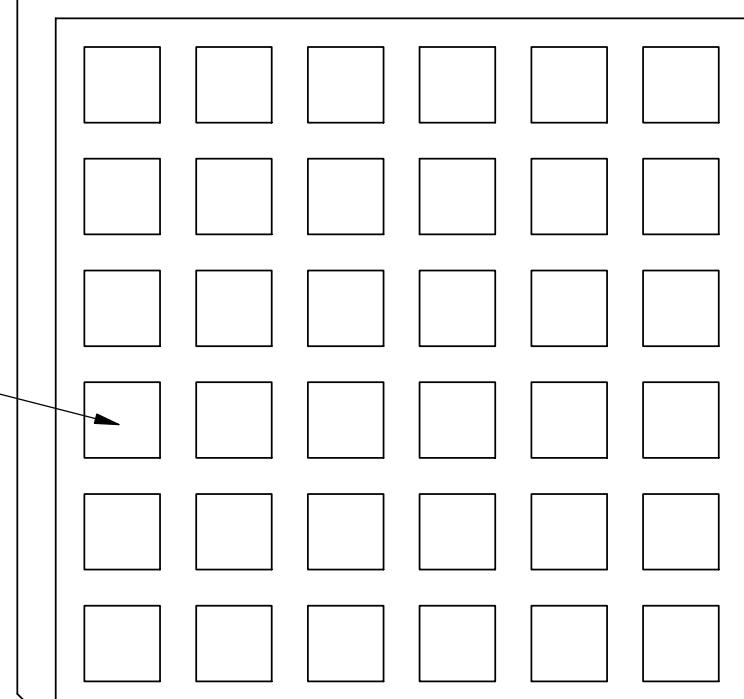
B D F H K M P T V Y AB AD AF AH AK AM AP AT AV AY BB BD BF BH BK
A C E G J L N R U W AA AC AE AG AJ AL AN AR AU AW BA BC BE BG BJ



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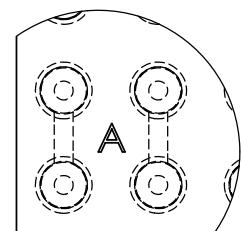
TopLine			
TITLE WLP2500T.3-DC507D			
	2500-L P=0.3mm		
SCALE 10:1	SIZE A	DRAWING NO. 535070	REV B
DO NOT SCALE DRAWING			SHEET 4 OF 6

TOP VIEW

WLP ORIENTATION
WAFFLE PACKTYPICAL WAFFLE PACK
IC CHIP TRAY
SCALE = 2:1PIN 1
CHAMFER

Notes: (Unless Otherwise Specified).

- 1) EXAMPLE OF TOP SIDE LASER MARKING.
- 2) ORIENT LETTERS FOR LOCATION OF PIN A1 CORNER.
- 3) ALLOWABLE LETTER MARKING: A, F, T, M, L, Y, AND P.
- 4) SINGLE LETTER IS REPEATED MULTIPLE TIMES ACROSS TOP SIDE.
- 5) DAISY CHAIN IS HIDDEN UNDER RESIN ON BALL SIZE.
- 6) TOP SIDE DOES NOT HAVE A DOT FOR LOCATION OF PIN A1.
- 7) LETTERS ARE NOT MARKED ON BOTTOM (BALL) SIDE.

DAISY CHAIN
ORIENTATIONDETAIL C
SCALE 25 : 1

MARKING CODE	
PITCH	LETTER
0.3MM	A
0.4MM	A OR F
0.5MM	A OR P

* SUBJECT TO CHANGE

TopLine

TITLE WLP2500T.3-DC507D
2500-L P=0.3mm
SCALE 12.5:1 SIZE A DRAWING NO. 535070 REV B

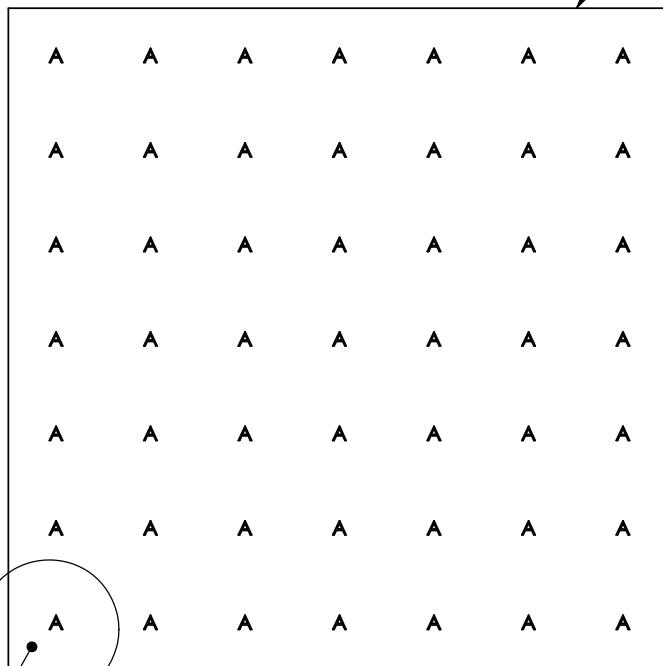
DO NOT SCALE DRAWING

SHEET 5 OF 6

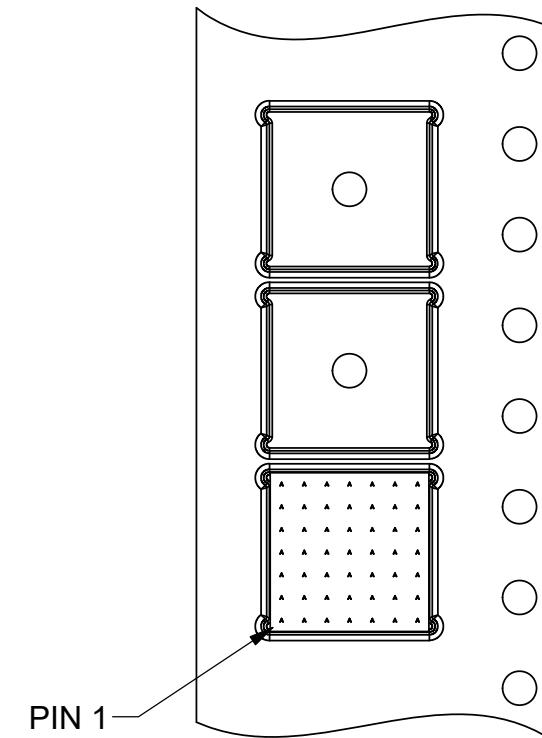
WLP ORIENTATION
TAPE AND REEL

TOP VIEW

SILICON (Si)



PIN 1
D
EXAMPLE ORIENTATION
OF MARKINGS ON WLP



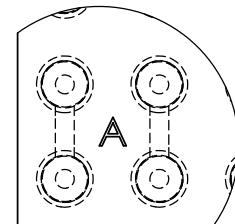
DIRECTION OF FEED

Notes: (Unless Otherwise Specified).

- 1) EXAMPLE OF TOP SIDE LASER MARKING.
- 2) ORIENT LETTERS FOR LOCATION OF PIN A1 CORNER.
- 3) ALLOWABLE LETTER MARKING: A, F, T, M, L, Y, AND P.
- 4) SINGLE LETTER IS REPEATED MULTIPLE TIMES ACROSS TOP SIDE.
- 5) DAISY CHAIN IS HIDDEN UNDER RESIN ON BALL SIZE.
- 6) TOP SIDE DOES NOT HAVE A DOT FOR LOCATION OF PIN A1.
- 7) LETTERS ARE NOT MARKED ON BOTTOM (BALL) SIDE.

MARKING CODE	
PITCH	LETTER
0.3MM	A
0.4MM	A OR F
0.5MM	A OR P

* SUBJECT TO CHANGE



DAISY CHAIN
ORIENTATION
DETAIL D
SCALE 25 : 1

TopLine			
TITLE	WLP2500T.3-DC507D 2500-L P=0.3mm		
SCALE	12.5:1	SIZE	DRAWING NO. 535070
REV B		DO NOT SCALE DRAWING	
SHEET 6 OF 6			